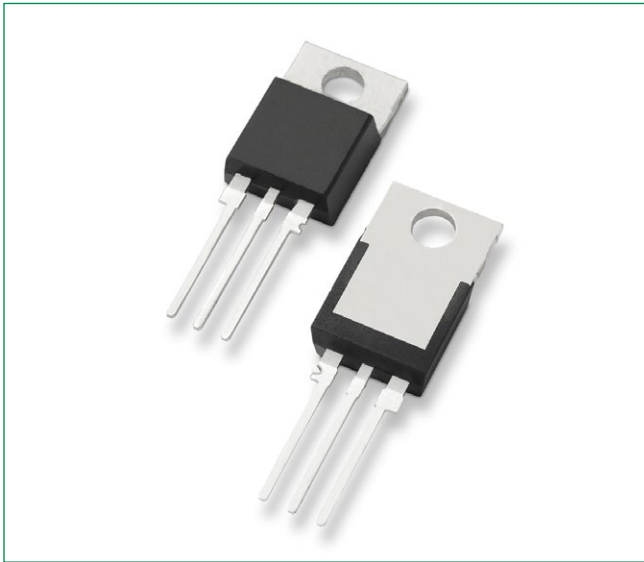


MCR310



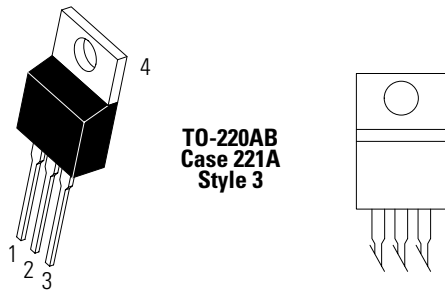
Description

Designed for industrial and consumer applications such as temperature, light and speed control; process and remote controls; warning systems; capacitive discharge circuits and MPU interface.

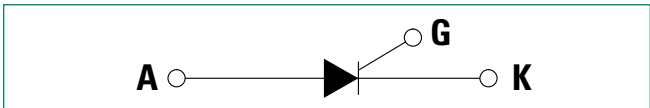
Features

- Center Gate Geometry for Uniform Current Density
- All Diffused and Glass-Passivated Junctions for Parameter Uniformity and Stability
- Small, Rugged, Thermowatt Construction for Low Thermal Resistance, High Heat Dissipation and Durability
- Low Trigger Currents, 200 μ A Maximum for Direct Driving from Integrated Circuits
- Pb-Free Packages are Available

Pin Out



Functional Diagram



Additional Information

Datasheet

Resources

Samples

Maximum Ratings ($T_J = 25^\circ\text{C}$ unless otherwise noted)

Rating	Part Number	Symbol	Value	Unit
Peak Repetitive Off-State Voltage (Note 1) ($T_J = -40$ to $+125^\circ\text{C}$, Gate Open)	MCR310-6 MCR310-8 MCR310-10	V_{DRM} V_{RRM}	400 600 800	V
On-State RMS Current ($T_C = 75^\circ\text{C}$)		$I_{\text{T(RMS)}}$	10	A
Peak Non-Repetitive Surge Current (1/2 Cycle, 60 Hz, $T_J = -40$ to 110°C)		I_{TSM}	100	A
Circuit Fusing ($t = 8.3$ ms)		I^2t	40	A^2sec
Peak Gate Voltage ($t \leq 10$ μs)		V_{GM}	± 5	V
Peak Gate Current ($t \leq 10$ μs)		I_{GM}	1	A
Peak Gate Power ($t \leq 10$ μs)		P_{GM}	5	W
Average Gate Power		$P_{\text{G(AV)}}$	0.75	W
Operating Junction Temperature Range		T_J	-40 to +110	$^\circ\text{C}$
Storage Temperature Range		T_{stg}	-40 to +150	$^\circ\text{C}$
Mounting Torque		–	8.0	in. lb.

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

- VDRM and VRRM for all types can be applied on a continuous basis. Ratings apply for zero or negative gate voltage; however, positive gate voltage shall not be applied concurrent with negative potential on the anode. Blocking voltages shall not be tested with a constant current source such that the voltage ratings of the devices are exceeded.

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Thermal Resistance, Junction-to-Case	$R_{\theta\text{JC}}$	2.2	$^\circ\text{C}/\text{W}$
Thermal Resistance, Junction-to-Ambient	$R_{\theta\text{JA}}$	60	

Electrical Characteristics ($T_C = 25^\circ\text{C}$, $R_{\text{GK}} = 1$ k Ω unless otherwise noted)

Characteristic	Symbol	Min	Typ	Max	Unit	
Peak Forward Blocking Current (Note 1) ($T_J = 110^\circ\text{C}$, $V_D = \text{Rated } V_{\text{DRM}}$)	I_{DRM}	$T_C = 110^\circ\text{C}$	–	–	500	μA
		$T_C = 25^\circ\text{C}$	–	–	10	
Peak Reverse Blocking Current (Note 1) ($T_J = 110^\circ\text{C}$, $V_R = \text{Rated } V_{\text{DRM}}$)	I_{RRM}	$T_C = 110^\circ\text{C}$	–	–	500	μA
		$T_C = 25^\circ\text{C}$	–	–	10	
On-State Voltage ($I_{\text{TM}} = 20$ A Peak, Pulse Width ≤ 1 ms, Duty Cycle $\leq 2\%$)	V_{TM}	–	1.7	2.2	V	
Gate Trigger Current Continuous dc (Note 2) ($V_D = 12$ Vdc, $R_L = 100$ Ω)	I_{GT}	–	30	200	μA	
Gate Trigger Voltage, Continuous dc ($V_D = \text{Rated } V_{\text{DRM}}$, $R_L = 10$ k Ω , $T_J = 110^\circ\text{C}$)	V_{GT}	– 0.1	0.5 –	1.5 –	mA	
Holding Current ($V_D = 12$ V, $I_{\text{TM}} = 100$ mA)	I_{H}	–	–	6	mA	
Critical Rate of Rise of Forward Blocking Voltage ($V_D = \text{Rated } V_{\text{DRM}}$, $T_J = 110^\circ\text{C}$, Exponential Waveform)	dv/dt	–	10	–	V/ μs	
Gate Controlled Turn-On Time ($V_D = \text{Rated } V_{\text{DRM}}$, $I_{\text{TM}} = 20$ A, $I_G = 2$ mA)	t_{gt}	–	1	–	μs	

1. Ratings apply for negative gate voltage or RGK = 1 k Ω . Devices shall not have a positive gate voltage concurrently with a negative voltage on the anode. Devices should not be tested with a constant current source for forward and reverse blocking capability such that the voltage applied exceeds the rated blocking voltage.

2. Does not include RGK current.

Figure 1. Typical RMS Current Derating

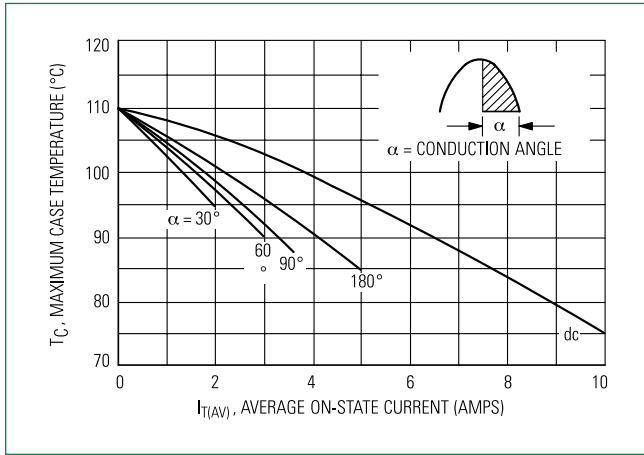


Figure 2. Peak Capacitor Discharge Current Derating

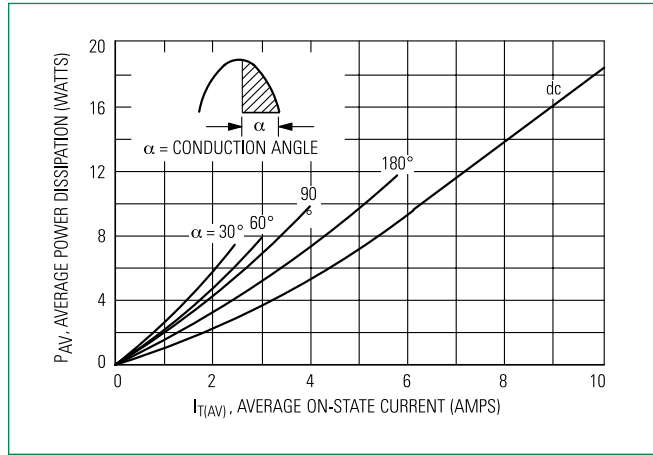


Figure 3. Current Derating

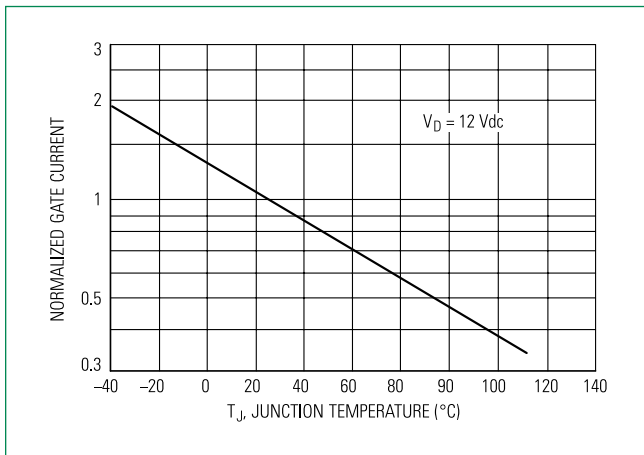
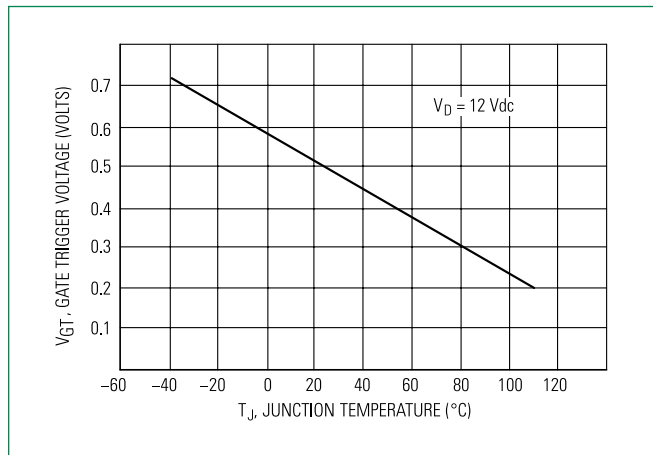
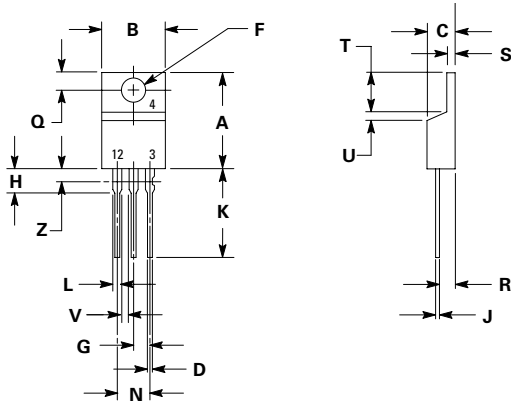


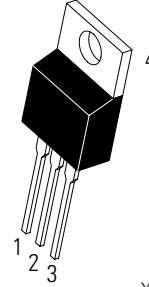
Figure 4. Maximum Power Dissipation



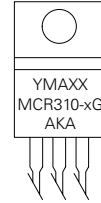
Dimensions



Part Marking System



**TO-220AB
Case 221A
Style 3**



Y =Year
M =Month
A =Assembly Site
AKA =Diode Polarity
G =Pb-Free Package

Dim	Inches		Millimeters	
	Min	Max	Min	Max
A	0.590	0.620	14.99	15.75
B	0.380	0.420	9.65	10.67
C	0.178	0.188	4.52	4.78
D	0.025	0.035	0.64	0.89
F	0.142	0.147	3.61	3.73
G	0.095	0.105	2.41	2.67
H	0.110	0.130	2.79	3.30
J	0.018	0.024	0.46	0.61
K	0.540	0.575	13.72	14.61
L	0.060	0.075	1.52	1.91
N	0.195	0.205	4.95	5.21
Q	0.105	0.115	2.67	2.92
R	0.085	0.095	2.16	2.41
S	0.045	0.060	1.14	1.52
T	0.235	0.255	5.97	6.47
U	0.000	0.050	0.00	1.27
V	0.045	---	1.15	---
Z	---	0.080	---	2.04

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.
3. DIMENSION Z DEFINES A ZONE WHERE ALL BODY AND LEAD IRREGULARITIES ARE ALLOWED.

Pin Assignment	
1	Cathode
2	Anode
3	Gate
4	Anode

Ordering Information

Device	Package	Shipping
MCR310-6	TO-220AB	500 Units / Box
MCR310-6G	TO-220AB (Pb-Free)	
MCR310-8	TO-220AB	
MCR310-8G	TO-220AB (Pb-Free)	
MCR310-10	TO-220AB	
MCR310-10G	TO-220AB (Pb-Free)	

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- Поставка более 17-ти миллионов наименований электронных компонентов;
- Поставка сложных, дефицитных, либо снятых с производства позиций;
- Оперативные сроки поставки под заказ (от 5 рабочих дней);
- Экспресс доставка в любую точку России;
- Техническая поддержка проекта, помощь в подборе аналогов, поставка прототипов;
- Система менеджмента качества сертифицирована по Международному стандарту ISO 9001;
- Лицензия ФСБ на осуществление работ с использованием сведений, составляющих государственную тайну;
- Поставка специализированных компонентов (Xilinx, Altera, Analog Devices, Intersil, Interpoint, Microsemi, Aeroflex, Peregrine, Syfer, Eurofarad, Texas Instrument, Miteq, Cobham, E2V, MA-COM, Hittite, Mini-Circuits, General Dynamics и др.);

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- Подбор аналогов;
- Консультации по применению компонента;
- Поставка образцов и прототипов;
- Техническая поддержка проекта;
- Защита от снятия компонента с производства.



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